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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/769,047	01/30/2004	S. Brad Herner	SAND-01138US0	7037
	7590 11/01/2007 LARDNER LLP		EXAMINER	
SUITE 500			CHEN, BRET P	
3000 K STREET NW WASHINGTON, DC 20007			ART UNIT	PAPER NUMBER
W115111110101			1792	· · · · · · · · · · · · · · · · · · ·
			MAIL DATE	DELIVERY MODE
			11/01/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)	
	10/769,047	HERNER ET AL.	
Office Action Summary	Examiner	Art Unit	
	B. Chen	1792	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address	
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).	
Status			
Responsive to communication(s) filed on 8/15/0 2a) This action is FINAL . 2b) This 3) Since this application is in condition for alloward closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro	•	
Disposition of Claims			
4) Claim(s) 2-5,7-11,13 and 15-19 is/are pending 4a) Of the above claim(s) is/are withdray 5) Claim(s) is/are allowed. 6) Claim(s) 2-5,7-11,13 and 15-19 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or	vn from consideration.		
Application Papers			
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) access Applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction of the original transfer and the correction of the correction of the original transfer and the correction of	epted or b) objected to by the Edrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau * See the attached detailed Office action for a list of	s have been received. s have been received in Application ity documents have been receive (PCT Rule 17.2(a)).	on No ed in this National Stage	
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	nte	

Application/Control Number: 10/769,047

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DETAILED ACTION

Claims 2-5, 7-11, 13, 15-19 are pending in this application. Amended claims 2, 9, 13, 15, 17, 19 and canceled claim 14 are noted.

The amendment dated 8/15/07 has been entered and carefully considered. The examiner appreciates the amendments to the claims. In view of the Herner Declaration dated 4/26/07, the rejection over Noda has been withdrawn.

Claim Rejections - 35 USC § 103

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claims 2-5, 7-11, 13, 15-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Noda et al. (6,905,963) in view of

Noda discloses a semiconductor device fabricating method for forming a boron doped polysilicon film on one or more substrates in a reaction furnace of a low pressure CVD apparatus by using SiH₄ and BCl₃ as reaction gases, comprising loading one or more substrates into the reaction furnace and forming the boron doped silicon film at a temperature of about 460 to 600°C (col.2 lines 25-46). A substrate boat can be utilized to hold the substrates (col.2 lines 65-67 and Figure 1) and a purge gas of nitrogen is used (col.6 lines 1-19). The partial pressures of the precursors (example 1), and the flow rates (example 2) are varied to optimize film properties. However, the reference fails to teach the appropriate temperature range as recited in independent claim 17.

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It is noted that Noda's temperature range overlaps the applicant's claimed temperature range. Overlapping ranges are *prima facie* evidence of obviousness. It would have been obvious to one having ordinary skill in the art to have selected the portion of Noda's temperature range that corresponds to the claimed range.

In addition, the reference remains silent on an average concentration of boron within the film. Yamazaki discloses a method of manufacturing a semiconductor device using a gettering technique by adding a metallic element having a catalytic action in crystallizing a semiconductor film (para 2). Specifically, a dopant such as phosphorous is injected into the crystalline semiconductor film by dissociating PH3 or the like by a plasma, accelerating the ions by using an electric field, and injecting the ions into the semiconductor film to obtain better recrystallization; the ion doping method is basically a method in which separation of mass of ions is not performed). The concentration of phosphorous necessary for gettering is equal to or greater than 1x10²⁰/cm³ (para 9) and can be varied by changing the convenctation of the precursors (para 13, 78, 105, 115). In a specific embodiment, boron can be used as the dopant and the concentration can be $6x10^{19}$ to $6x10^{20}$ /cm³ (para 123). It is well known in the art to utilize the specific boron concentration as noted above in Yamazaki. The reference also teaches the conventionality of varying the concentration by varying flow rates and temperature. It would have been obvious to utilize the boron concentration of Yamazaki in Noda's process with the expectation of obtaining better recrystallization.

The limitations of claims 2-5, 7-11, 13, 15-16, 18-19 have been addressed above.

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Response to Arguments

Applicant's arguments with respect to the claims above have been considered but are moot in view of the new ground(s) of rejection.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to B. Chen whose telephone number is (571) 272-1417. The examiner can normally be reached on 7:30am - 4:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Timothy Meeks can be reached on (571) 272-1423. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Bc 10/29/07

BRET CHEN
PRIMARY EXAMINER